

Specifications

PCI-DAS6070



**MEASUREMENT
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Specifications

Typical for 25°C unless otherwise specified.

Analog Input Section

A/D converter type	Successive Approximation
Maximum Sample Rate	1.25 MS/s
Resolution	12 bits, 1-in-4096
Number of channels	16 single ended / 8 differential, Software selectable
Input ranges	Bipolar: $\pm 10V$, $\pm 5V$, $\pm 2.5V$, $\pm 1V$, $\pm 0.5V$, $\pm 0.25V$, $\pm 0.1V$, $\pm 0.05V$, Unipolar: 0 to 10V, 0 to 5V, 0 to 2V, 0 to 1V, 0 to 0.5V, 0 to 0.2V, 0 to 0.1V Software selectable
A/D pacing (SW programmable)	Internal counter – ASIC. Software selectable time base: - Internal 40MHz, 50ppm stability - External Source via AUXIN<5:0>, Software selectable.
	External convert strobe: A/D CONVERT
	Software paced
Burst mode	Software selectable option, burst rate = 800nS
A/D Gate Sources	External digital: A/D GATE
	External analog: ATRIG input CH0 IN through CH15 IN
A/D gating modes	External digital: Programmable, active high or active low, level or edge
	External analog: See Analog Trigger section
A/D trigger sources	External digital: A/D START TRIGGER A/D STOP TRIGGER
	External analog: ATRIG input CH0 IN through CH15 IN
A/D triggering modes	External digital: Software-configurable for rising or falling edge.
	External analog: See Analog Trigger section
	Pre-/Post-trigger: Unlimited number of pre-trigger samples, 16 Meg post-trigger samples.
ADC Pacer Out	Available at user connector: A/D PACER OUT
RAM buffer size	8K samples
Data transfer	DMA
	Programmed I/O
DMA Modes	Demand or Non-Demand using scatter gather.
Configuration Memory	Up to 8K elements. Programmable channel, gain, and offset
Streaming-to-disk rate	1.25 MS/s, system dependent

Accuracy

1.25 MS/s rate, single channel operation and a 15-minute warm-up. Accuracies listed are for measurements made following an internal calibration. They are valid for operational temperatures within $\pm 1^{\circ}\text{C}$ of internal calibration temperature and $\pm 10^{\circ}\text{C}$ of factory calibration temperature. Calibrator test source high side tied to Channel 0 High and low side tied to Channel 0 Low. Low-level ground is tied to Channel 0 Low at the user connector.

Table 1. Absolute Accuracy

Range	Absolute Accuracy (LSB)
$\pm 10\text{V}$	± 2.9
$\pm 5\text{V}$	± 2.1
$\pm 2.5\text{V}$	± 3.0
$\pm 1\text{V}$	± 3.0
$\pm 500\text{mV}$	± 3.0
$\pm 250\text{mV}$	± 3.1
$\pm 100\text{mV}$	± 3.3
$\pm 50\text{mV}$	± 3.7
0 to 10V	± 2.8
0 to 5V	± 4.4
0 to 2V	± 4.4
0 to 1V	± 4.5
0 to 500mV	± 4.6
0 to 200mV	± 4.8
0 to 100mV	± 5.2

Table 2. Absolute Accuracy components - All values are ($\pm$)

Range	% of Reading	Offset (mV)	Noise + Quantization (mV)		Temp Drift (%/DegC)	Absolute Accuracy at FS (mV)
			Single Pt	Averaged ¹		
$\pm 10\text{V}$	0.0714	6.38	6.10	0.846	0.0010	14.369
$\pm 5\text{V}$	0.0314	3.20	3.05	0.423	0.0005	5.193
$\pm 2.5\text{V}$	0.0714	1.61	1.53	0.211	0.0010	3.605
$\pm 1\text{V}$	0.0714	0.653	0.610	0.085	0.0010	1.452
$\pm 500\text{mV}$	0.0714	0.335	0.305	0.042	0.0010	0.735
$\pm 250\text{mV}$	0.0714	0.176	0.208	0.024	0.0010	0.379
$\pm 100\text{mV}$	0.0714	0.081	0.098	0.011	0.0010	0.163
$\pm 50\text{mV}$	0.0714	0.049	0.071	0.007	0.0010	0.091
0 to 10V	0.0314	3.20	3.05	0.423	0.0005	6.765
0 to 5V	0.0714	1.61	1.53	0.211	0.0010	5.391
0 to 2V	0.0714	0.653	0.610	0.085	0.0010	2.167

Range	% of Reading	Offset (mV)	Noise + Quantization (mV)		Temp Drift (%/DegC)	Absolute Accuracy at FS (mV)
			Single Pt	Averaged ¹		
0 to 1V	0.0714	0.335	0.305	0.042	0.0010	1.092
0 to 500mV	0.0714	0.176	0.208	0.024	0.0010	0.558
0 to 200mV	0.0714	0.081	0.098	0.011	0.0010	0.235
0 to 100mV	0.0714	0.049	0.071	0.007	0.0010	0.127

1. Averaged measurements assume dithering and averaging of 100 single-channel readings

Each PCI-DAS6070 is tested at the factory to assure the board's overall error does not exceed absolute accuracy limits described in Table 1 above.

Table 3. Relative Accuracy - All values are ($\pm$)

Range	Relative Accuracy (mV)	
	Single Point	Averaged ¹
$\pm 10V$	7.37	1.11
$\pm 5V$	3.68	0.557
$\pm 2.5V$	1.84	0.278
$\pm 1V$	0.737	0.111
$\pm 500mV$	0.368	0.056
$\pm 250mV$	0.238	0.032
$\pm 100mV$	0.111	0.015
$\pm 50mV$	0.082	0.009
0 to 10V	3.68	0.557
0 to 5V	1.84	0.278
0 to 2V	0.737	0.111
0 to 1V	0.368	0.056
0 to 500mV	0.238	0.032
0 to 200mV	0.111	0.015
0 to 100mV	0.082	0.009

1. Averaged measurements assume dithering and averaging of 100 single-channel readings

Relative accuracy is defined as the measured deviation from a straight line drawn between measured endpoints of the transfer function. ADC resolution, noise and front-end non-linearity are included in this measurement.

Table 4. Differential non-linearity

All Ranges	± 0.5 LSB typ	± 1.0 LSB max
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Settling Time

Settling time is defined here as the time required for a channel to settle to within a specified accuracy in response to a full-scale (FS) step. Two channels are scanned at a specified rate. A –FS DC signal is presented to Channel 1; a +FS DC signal is presented to Channel 0.

Condition	Range	Accuracy			
			±0.012% (±0.5 LSB)	±0.024% (±1.0 LSB)	±0.098% (±4.0 LSB)
Same range to same range	±10V	Typ	2.0µS	1.5µS	1.5µS
		Max	3.0µS	2.0µS	2.0µS
	±5V	Typ	2.0µS	1.5µS	1.3µS
		Max	3.0µS	2.0µS	1.5µS
	±2.5V	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	±1V	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	±500mV	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	±250mV	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	±100mV	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	±50mV	Typ	2.0µS	1.5µS	1.0µS
		Max	3.0µS	2.0µS	1.5µS
	0 to 10V	Typ	2.0µS	1.5µS	1.3µS
		Max	3.0µS	2.0µS	1.5µS
	0 to 5V	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	0 to 2V	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	0 to 1V	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	0 to 500mV	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	0 to 200mV	Typ	2.0µS	1.5µS	0.9µS
		Max	3.0µS	2.0µS	1.0µS
	0 to 100mV	Typ	2.0µS	1.5µS	1.0µS
		Max	3.0µS	2.0µS	1.5µS

Parametrics

Max working voltage (signal + common-mode)	Input must remain within $\pm 11\text{V}$ of ground	
CMRR @ 60Hz	$\pm 10\text{V}$	95 dB
	$\pm 5\text{V}$, 0 to 10V	100 dB
	All other ranges	106 dB
Small signal bandwidth, all ranges	1.6 MHz	
Large signal bandwidth, all ranges	1.0 MHz	
Input coupling	DC	
Input impedance	100 Gohm in parallel with 100pF in normal operation.	
	820 Ohm in powered off or overload condition.	
Input bias current	$\pm 200\text{ pA}$	
Input offset current	$\pm 100\text{ pA}$	
Absolute maximum input voltage	± 25 power on, $\pm 15\text{V}$ power off. Protected Inputs: - CH0 IN through CH15 IN - AISENSE	
Crosstalk, DC to 100 kHz	Adjacent Channels: -75 dB	
	All other Channels: -90 dB	

Noise Performance

Table 5 below summarizes the noise performance for the PCI-DAS6070. Noise distribution is determined by gathering 50K samples with inputs tied to ground at the user connector. Samples are gathered at the maximum specified single-channel sampling rate. Specification applies to both single-ended and differential modes of operation.

Table 5. Analog Input Noise Performance (not including quantization)

Range	Counts Dithered	LSBrms Dithered	Counts Undithered	LSBrms Undithered
$\pm 10\text{V}$	5	0.5	3	0.25
$\pm 5\text{V}$	5	0.5	3	0.25
$\pm 2.5\text{V}$	5	0.5	3	0.25
$\pm 1\text{V}$	5	0.5	3	0.25
$\pm 500\text{ mV}$	6	0.5	3	0.25
$\pm 250\text{ mV}$	6	0.6	4	0.4
$\pm 100\text{ mV}$	7	0.7	5	0.5
$\pm 50\text{ mV}$	9	0.9	8	0.8
0 to 10V	5	0.5	3	0.25
0 to 5V	5	0.5	3	0.25
0 to 2V	5	0.5	3	0.25

Range	Counts Dithered	LSBrms Dithered	Counts Undithered	LSBrms Undithered
0 to 1V	6	0.5	3	0.25
0 to 500 mV	6	0.6	4	0.4
0 to 200 mV	7	0.7	5	0.5
0 to 100 mV	9	0.9	8	0.8

Analog Output Section

D/A Converter type	Double-buffered, multiplying
Resolution	12-bits, 1-in-4096
Number of Channels	2 voltage output
Voltage Range	±10V, 0 to 10V, ±EXT REF., 0 to EXT REF., software selectable
Monotonicity	12-bits, guaranteed
Slew Rate	20 V/μs min
Settling Time (full scale step)	3.0 μs to ±0.5 LSB accuracy
Noise	200 μVrms, DC to 1MHz BW
Glitch Energy	±20 mV @ 1.5μs duration measured at mid-scale transition.
Current Drive	±5 mA
Output short-circuit duration	Indefinite @25mA
Output coupling	DC
Output impedance	0.1 ohms max
Gain temperature coefficient, internal or external reference	25 ppm/°C
Offset temperature coefficient	±50 μV/°C
Power up and reset	DACs cleared to 0 volts ±200 mV max

Table 6. Analog Output Absolute Accuracy

Range	Absolute Accuracy (LSB)
±10V	±1.7 LSB
0 to 10V	±2.3 LSB

Table 7. Analog Output Absolute Accuracy Components

Range	% of Reading	Offset (mV)	Temp Drift (%/DegC)	Absolute Accuracy at FS (mV)
±10V	±0.0219	±5.93	±0.0005	±8.127
0 to 10V	±0.0219	±3.49	±0.0005	±5.685

Each PCI-DAS6070 is tested at the factory to assure the board's overall error does not exceed the limits listed in *Table 6* above.

Table 8. Relative Accuracy

Range	Relative Accuracy	
All Ranges	± 0.3 LSB, typical	± 0.5 LSB, max

Relative accuracy is defined as the measured deviation from a straight line drawn between measured endpoints of the transfer function.

Table 9. Differential non-linearity

All Ranges	± 0.3 LSB, typical	± 1.0 LSB, max
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Analog Output Pacing and Triggering

DAC Pacing (SW programmable)	Internal counter – ASIC. Selectable time base:	
	- Internal 40 MHz - External Source via AUXIN<5:0>, SW selectable.	
	External convert strobe: D/A UPDATE	
DAC Gate Source (Software programmable)	Software paced	
	External digital:	D/A START TRIGGER
	External analog:	ATRIG input CH0 IN through CH15 IN
	Software gated	
DAC Gating Modes	External digital: Programmable, active high or active low, level or edge	
	External analog: See Analog Trigger section	
DAC Trigger Sources	External digital:	D/A START TRIGGER
	External analog:	ATRIG input CH0 IN through CH15 IN
	Software triggered	
DAC Triggering Modes	External digital:	Software-configurable for rising or falling edge.
	External analog:	See Analog Trigger section on page 8
DAC Pacer Out	Available at user connector: D/A PACER OUT	
RAM Buffer Size	16K samples	
Data transfer	DMA	
	Programmed I/O	
	Update DACs individually or simultaneously, software selectable.	
DMA Modes	Demand or Non-Demand using scatter gather.	
Waveform generation throughput	1 MS/s max per channel, 2 channels simultaneous	

Analog Output External Reference Input (D/A EXTREF)

Range	$\pm 11\text{V}$
Overvoltage Protection	$\pm 25\text{V}$ powered on, $\pm 15\text{V}$ powered off
Input Impedance	10k ohms
Bandwidth (-3dB)	1 MHz
Gain Error – EXTREF mode	0 to 0.5%, not adjustable.

Analog Trigger

Analog Trigger Sources Software selectable	External: ATRIG input CH0 IN through CH15 IN, first channel in scan	
Analog Trigger Levels	ATRIG input: $\pm 10\text{V}$	
	CH0 IN through CH15 IN: $\pm$ Full-scale, range dependent	
Analog Trigger Modes	External analog: Software-configurable for: ▪ Positive or Negative slope	
Analog Gate Modes	External analog: Software-configurable for: ▪ Above or Below reference ▪ Positive or Negative hysteresis ▪ In or Out of window	
Resolution	8-bits, 1-in-256	
Accuracy	$\pm 5\%$ Full-scale range max	
Bandwidth (-3 dB)	ATRIG input	1.3 MHz
	CH0 IN through CH15 IN	2.0 MHz

Analog Input / Output Calibration

Recommended warm-up time	15 minutes	
Calibration	Auto-calibration, calibration factors for each range stored on board in non-volatile RAM.	
Onboard calibration reference	DC Level: $5.000\text{V} \pm 2.5 \text{ mV}$. Actual measured values stored in EEPROM.	
	Tempco: 5 ppm/ $^{\circ}\text{C}$ max, 2 ppm/ $^{\circ}\text{C}$ typical	
	Long-term stability: 20 ppm, T = 1000 hrs, non-cumulative	
Calibration interval	1 year	

Digital Input / Output

Digital Type	Discrete, 5V/TTL compatible
Number of I/O	8
Configuration	8 bits, independently programmable for input or output. All pins pulled up to +5V via 47K resistors (default). Positions available for pull down to ground. Hardware selectable via solder gap.
Input high voltage	2.0V min, 7.0V absolute max
Input low voltage	0.8V max, -0.5V absolute min
Output high voltage (IOH = -32 mA)	3.80V min, 4.20V typ
Output low voltage (IOL = 32mA)	0.55V max, 0.22V typ
Data Transfer	Programmed I/O
Power-up / reset state	Input mode (high impedance)

Interrupt Section

Interrupts	PCI INTA# - mapped to IRQn via PCI BIOS at boot-time
Interrupt enable	Programmable through PLX9080
ADC Interrupt sources (Software Programmable)	DAQ_ACTIVE: Interrupt is generated when a DAQ sequence is active.
	DAQ_STOP: Interrupt is generated when A/D Stop Trigger In is detected.
	DAQ_DONE: Interrupt is generated when a DAQ sequence completes.
	DAQ_FIFO_1/4_FULL: Interrupt is generated when ADC FIFO is 1/4 full.
	DAQ_SINGLE: Interrupt is generated after each conversion completes.
	DAQ_EOSCAN: Interrupt is generated after the last channel is converted in multi-channel scans.
DAC Interrupt sources (Software Programmable)	DAQ_EOSEQ: Interrupt is generated after each interval delay during multi-channel scans.
	DAC_ACTIVE: Interrupt is generated when DAC waveform circuitry is active.
	DAC_DONE: Interrupt is generated when a DAC sequence completes.
	DAC_FIFO_1/4_EMPTY: Interrupt is generated when the DAC FIFO is 1/4 empty.
	DAC_HIGH_CHANNEL: Interrupt is generated when the DAC high channel output is updated.

Counter Section

User counter type	82C54
Number of Channels	2
Resolution	16-bits
Compatibility	5V/TTL
CTRn base clock source (Software selectable)	Internal 10 MHz, Internal 100 kHz or External connector (CTRn CLK)
Internal 10 MHz clock source stability	50ppm
Counter n Gate	Available at connector (CTRn GATE).
Counter n Output	Available at connector (CTRn OUT).
Clock input frequency	10 MHz max
High pulse width (clock input)	15 ns min
Low pulse width (clock input)	25 ns min
Gate width high	25 ns min
Gate width low	25 ns min
Input low voltage	0.8V max
Input high voltage	2.0V min
Output low voltage	0.4V max
Output high voltage	3.0V min

Configurable AUXIN<5:0>, AUXOUT<2:0> External Trigger/Clocks

The PCI-DAS6070 provides nine user-configurable Trigger/Clock pins that are available at the 100-pin I/O connector. Of these, six are configurable as inputs while three are configurable as outputs.

AUXIN<5:0> Sources (SW selectable)	A/D CONVERT: A/D TIMEBASE IN: A/D START TRIGGER: A/D STOP TRIGGER: A/D PACER GATE: D/A START TRIGGER D/A UPDATE: D/A TIMEBASE IN:	External ADC convert strobe External ADC pacer timebase ADC Start Trigger ADC Stop Trigger External ADC gate DAC trigger/gate DAC update strobe External DAC pacer time base
AUXOUT<2:0> Sources (SW Selectable)	STARTSCAN: SSH: A/D STOP: A/D CONVERT: SCANCLK: CTR1 CLK D/A UPDATE CTR2 CLK A/D START TRIGGER: A/D STOP TRIGGER: A/D PACER GATE: D/A START TRIGGER:	A pulse indicating start of conversion Active signal that terminates at the start of the last conversion in a scan. Indicates end of a scan ADC convert pulse Delayed version of ADC convert CTR1 clock source D/A update pulse CTR2 clock source ADC Start Trigger Out ADC Stop Trigger Out External ADC gate DAC Start Trigger Out
Default Selections:	AUXIN0:	A/D CONVERT
	AUXIN1:	A/D START TRIGGER
	AUXIN2:	A/D STOP TRIGGER
	AUXIN3:	D/A UPDATE
	AUXIN4:	D/A START TRIGGER
	AUXIN5:	A/D PACER GATE
	AUXOUT0:	D/A UPDATE
	AUXOUT1:	A/D CONVERT
	AUXOUT2:	SCANCLK
Compatibility	5V/TTL	
Edge-sensitive polarity	Rising/falling, software selectable	
Level-sensitive polarity	Active high/active low, software selectable	
Minimum pulse width	3.75nS	

DAQ-Sync inter-board Triggers/Clocks

The DAQ-Sync bus provides inter-board triggering and synchronization capability. Five trigger/strobe I/O pins and one clock I/O pin are provided on a 14-pin header. The DAQ-Sync signals use dedicated pins. Only the direction may be set.

DAQ-Sync Signals	DS A/D START TRIGGER
	DS A/D STOP TRIGGER
	DS A/D CONVERT
	DS D/A UPDATE
	DS D/A START TRIGGER
	SYNC CLK

Power Consumption

+5V	0.9 A typical, 1.1 A max. Does not include power consumed through the I/O connector.
+5V available at I/O connector	1A max, protected with a resettable fuse

Environmental

Operating Temperature Range	0 to 55°C
Storage Temperature Range	-20 to 70°C
Humidity	0 to 90% non-condensing

Mechanical

Card dimensions	PCI half card: 174.6mm(L) x 106.9mm(W) x 11.65mm(H)
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DAQ-Sync Connector and Pin Out

Connector type	14-Pin right-angle 100mil box header
Compatible Cables	MCC p/n: CDS-14-x, 14 pin ribbon cable. x = number of boards (2 - 5)

Pin	Signal Name
1	DS A/D START TRIGGER
2	GND
3	DS A/D STOP TRIGGER
4	GND
5	DS A/D CONVERT
6	GND
7	DS D/A UPDATE
8	GND
9	DS D/A START TRIGGER
10	GND
11	RESERVED
12	GND
13	SYNC CLK
14	GND

Main Connector and Pin Out

Connector type	Shielded SCSI 100 D-Type
Compatible Cables	C100HD50-x, unshielded ribbon cable. x= 3 or 6 feet
	C100MMS-x, shielded round cable. x= 1, 2, or 3 meters
Compatible accessory products (with C100HD50-xx cable)	ISO-RACK16/P ISO-DA02/P BNC-16SE BNC-16DI CIO-MINI50 CIO-TERM100 SCB-50
Compatible accessory products (with C100MMS-x cable)	SCB-100

8 Channel Differential Mode

Pin	Signal Name	Pin	Signal Name
1	LLGND	51	n/c
2	CH0 IN HI	52	n/c
3	CH0 IN LO	53	n/c
4	CH1 IN HI	54	n/c
5	CH1 IN LO	55	n/c
6	CH2 IN HI	56	n/c
7	CH2 IN LO	57	n/c
8	CH3 IN HI	58	n/c
9	CH3 IN LO	59	n/c
10	CH4 IN HI	60	n/c
11	CH4 IN LO	61	n/c
12	CH5 IN HI	62	n/c
13	CH5 IN LO	63	n/c
14	CH6 IN HI	64	n/c
15	CH6 IN LO	65	n/c
16	CH7 IN HI	66	n/c
17	CH7 IN LO	67	n/c
18	LLGND	68	n/c
19	n/c	69	n/c
20	n/c	70	n/c
21	n/c	71	n/c
22	n/c	72	n/c
23	n/c	73	n/c
24	n/c	74	n/c
25	n/c	75	n/c
26	n/c	76	n/c
27	n/c	77	n/c
28	n/c	78	n/c
29	n/c	79	n/c
30	n/c	80	n/c
31	n/c	81	n/c
32	n/c	82	n/c
33	n/c	83	n/c
34	n/c	84	n/c
35	AISENSE	85	DIO0
36	D/A OUT 0	86	DIO1
37	D/A GND	87	DIO2
38	D/A OUT1	88	DIO3
39	PC +5 V	89	DIO4
40	AUXOUT0 / D/A PACER OUT	90	DIO5
41	AUXOUT1 / A/D PACER OUT	91	DIO6
42	AUXOUT2 / SCANCLK	92	DIO7
43	AUXIN0 / A/D CONVERT / ATRIG	93	CTR1 CLK
44	D/A EXTREF	94	CTR1 GATE
45	AUXIN1 / A/D START TRIGGER	95	CTR1 OUT
46	AUXIN2 / A/D STOP TRIGGER	96	GND
47	AUXIN3 / D/A UPDATE	97	CTR2 CLK
48	AUXIN4 / D/A START TRIGGER	98	CTR2 GATE
49	AUXIN5 / A/D PACER GATE	99	CTR2 OUT
50	GND	100	GND

16 Channel Single-Ended Mode

Pin	Signal Name	Pin	Signal Name
1	LLGND	51	n/c
2	CH0 IN	52	n/c
3	CH8 IN	53	n/c
4	CH1 IN	54	n/c
5	CH9 IN	55	n/c
6	CH2 IN	56	n/c
7	CH10 IN	57	n/c
8	CH3 IN	58	n/c
9	CH11 IN	59	n/c
10	CH4 IN	60	n/c
11	CH12 IN	61	n/c
12	CH5 IN	62	n/c
13	CH13 IN	63	n/c
14	CH6 IN	64	n/c
15	CH14 IN	65	n/c
16	CH7 IN	66	n/c
17	CH15 IN	67	n/c
18	LLGND	68	n/c
19	n/c	69	n/c
20	n/c	70	n/c
21	n/c	71	n/c
22	n/c	72	n/c
23	n/c	73	n/c
24	n/c	74	n/c
25	n/c	75	n/c
26	n/c	76	n/c
27	n/c	77	n/c
28	n/c	78	n/c
29	n/c	79	n/c
30	n/c	80	n/c
31	n/c	81	n/c
32	n/c	82	n/c
33	n/c	83	n/c
34	n/c	84	n/c
35	AISENSE	85	DIO0
36	D/A OUT 0	86	DIO1
37	D/A GND	87	DIO2
38	D/A OUT1	88	DIO3
39	PC +5 V	89	DIO4
40	AUXOUT0 / D/A PACER OUT	90	DIO5
41	AUXOUT1 / A/D PACER OUT	91	DIO6
42	AUXOUT2 / SCANCLK	92	DIO7
43	AUXIN0 / A/D CONVERT / ATRIG	93	CTR1 CLK
44	D/A EXTREF	94	CTR1 GATE
45	AUXIN1 / A/D START TRIGGER	95	CTR1 OUT
46	AUXIN2 / A/D STOP TRIGGER	96	GND
47	AUXIN3 / D/A UPDATE	97	CTR2 CLK
48	AUXIN4 / D/A START TRIGGER	98	CTR2 GATE
49	AUXIN5 / A/D PACER GATE	99	CTR2 OUT
50	GND	100	GND

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